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Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	·
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	16-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908qy4cdte

Email: info@E-XFL.COM

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Revision History

Revision History (Sheet 3 of 3)

Date	Revision Level	Description	Page Number(s)
		Reformatted to meet current documentation standards	Throughout
		6.3.1 BUSCLKX4 — Clarified description of BUSCLKX4	58
		Chapter 7 Central Processor Unit (CPU) — In 7.7 Instruction Set Summary: Reworked definitions for STOP instruction Added WAIT instruction	70 71
November, 2004	4.0	13.8.1 SIM Reset Status Register — Clarified SRSR flag setting	117
		14.9.1 TIM Status and Control Register — Added information to TSTOP note	127
		16.8 5-V Oscillator Characteristics — Added values for deviation from trimmed inernal oscillator	155
		16.12 3-V Oscillator Characteristics — Added values for deviation from trimmed inernal oscillator	158
		Figure 5-2. Configuration Register 1 (CONFIG1) — Clarified bit definitions for COPRS.	54
July,	C	Chapter 8 External Interrupt (IRQ) — Reworked for clarification.	73
2005	5.0	11.3.4 RC Oscillator — Improved RC oscillator wording.	93
		12.1 Introduction — Added note pertaining to non-bonded port pins.	97
		17.3 Package Dimensions — Updated package information.	165
March, 2010	6.0	Clarify internal oscillator trim register information.	26, 27, 31, 34, 35, 38, 91, 96



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Features of the CPU08 include the following:

- Enhanced HC05 programming model
- Extensive loop control functions
- 16 addressing modes (eight more than the HC05)
- 16-bit index register and stack pointer
- Memory-to-memory data transfers
- Fast 8 × 8 multiply instruction
- Fast 16/8 divide instruction
- Binary-coded decimal (BCD) instructions
- Optimization for controller applications
- Efficient C language support

1.3 MCU Block Diagram

Figure 1-1 shows the structure of the MC68HC908QY4.

1.4 Pin Assignments

The MC68HC908QT4, MC68HC908QT2, and MC68HC908QT1 are available in 8-pin packages and the MC68HC908QY4, MC68HC908QY2, and MC68HC908QY1 in 16-pin packages. Figure 1-2 shows the pin assignment for these packages.



Input/Output (I/O) Section

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
	FLASH Control Register	Read:	0	0	0	0	HVEN	MASS	ERASE	PGM
\$FE08	(FLCR)	Write:								
	See page 34.	Reset:	0	0	0	0	0	0	0	0
\$FE09	Break Address High Register (BRKH)	Read: Write:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
	See page 136.	Reset:	0	0	0	0	0	0	0	0
\$FE0A	Break Address low Register (BRKL)	Read: Write:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	See page 136.	Reset:	0	0	0	0	0	0	0	0
	Break Status and Control	Read:		BRKA	0	0	0	0	0	0
\$FE0B	Register (BRKSCR)	Write:	DRIVE							
	See page 136.	Reset:	0	0	0	0	0	0	0	0
	I VI Status Register	Read:	LVIOUT	0	0	0	0	0	0	R
\$FE0C	(LVISR)	Write:								
	See page 87.	Reset:	0	0	0	0	0	0	0	0
\$FE0D ↓ \$FE0F	Reserved for FLASH Test		R	R	R	R	R	R	R	R
		-								
\$FFBE	FLASH Block Protect Register (FLBPR)	Read: Write:	BPR7	BPR6	BPR5	BPR4	BPR3	BPR2	BPR1	BPR0
	See page 39.	Reset:				Unaffecte	d by reset			
\$FFBF	Reserved		R	R	R	R	R	R	R	R

		_								
\$FFC0	Internal Oscillator Trim (Factory Programmed,	Read: Write:	TRIM7	TRIM6	TRIM5	TRIM4	TRIM3	TRIM2	TRIM1	TRIM0
	VDD = 5.0 V)	Reset:				Unaffecte	d by reset			
\$FFC1	Internal Oscillator Trim (Factory Programmed,	Read: Write:	TRIM7	TRIM6	TRIM5	TRIM4	TRIM3	TRIM2	TRIM1	TRIM0
	VDD = 3.0 V)	Reset:				Unaffecte	d by reset			



Figure 2-2. Control, Status, and Data Registers (Sheet 5 of 5)





2.6.3 FLASH Mass Erase Operation

Use the following procedure to erase the entire FLASH memory to read as a 1:

- 1. Set both the ERASE bit and the MASS bit in the FLASH control register.
- 2. Read the FLASH block protect register.
- 3. Write any data to any FLASH address⁽¹⁾ within the FLASH memory address range.
- 4. Wait for a time, t_{NVS} (minimum 10 μ s).
- 5. Set the HVEN bit.
- 6. Wait for a time, t_{MErase} (minimum 4 ms).
- 7. Clear the ERASE and MASS bits.

NOTE

Mass erase is disabled whenever any block is protected (FLBPR does not equal \$FF).

- 8. Wait for a time, t_{NVHL} (minimum 100 μ s).
- 9. Clear the HVEN bit.
- 10. After time, t_{RCV} (typical 1 μ s), the memory can be accessed in read mode again.

NOTE

Programming and erasing of FLASH locations cannot be performed by code being executed from the FLASH memory. While these operations must be performed in the order as shown, but other unrelated operations may occur between the steps.

CAUTION

A mass erase will erase the internal oscillator trim values at \$FFC0 and \$FFC1.

2.6.4 FLASH Program Operation

Programming of the FLASH memory is done on a row basis. A row consists of 32 consecutive bytes starting from addresses \$XX00, \$XX20, \$XX40, \$XX60, \$XX80, \$XXA0, \$XXC0, or \$XXE0. Use the following step-by-step procedure to program a row of FLASH memory

Figure 2-4 shows a flowchart of the programming algorithm.

NOTE

Only bytes which are currently \$FF may be programmed.

- 1. Set the PGM bit. This configures the memory for program operation and enables the latching of address and data for programming.
- 2. Read the FLASH block protect register.
- 3. Write any data to any FLASH location within the address range desired.
- 4. Wait for a time, t_{NVS} (minimum 10 μ s).
- 5. Set the HVEN bit.
- 6. Wait for a time, t_{PGS} (minimum 5 μ s).
- 7. Write data to the FLASH address being programmed⁽²⁾.

^{1.} When in monitor mode, with security sequence failed (see 15.3.2 Security), write to the FLASH block protect register instead of any FLASH address.



Analog-to-Digital Converter (ADC)

3.3.2 Voltage Conversion

When the input voltage to the ADC equals V_{DD} , the ADC converts the signal to \$FF (full scale). If the input voltage equals V_{SS} , the ADC converts it to \$00. Input voltages between V_{DD} and V_{SS} are a straight-line linear conversion. All other input voltages will result in \$FF if greater than V_{DD} and \$00 if less than V_{SS} .

NOTE

Input voltage should not exceed the analog supply voltages.

3.3.3 Conversion Time

Sixteen ADC internal clocks are required to perform one conversion. The ADC starts a conversion on the first rising edge of the ADC internal clock immediately following a write to the ADSCR. If the ADC internal clock is selected to run at 1 MHz, then one conversion will take 16 μ s to complete. With a 1-MHz ADC internal clock the maximum sample rate is 62.5 kHz.

Conversion Time = $\frac{16 \text{ ADC Clock Cycles}}{\text{ADC Clock Frequency}}$

Number of Bus Cycles = Conversion Time \times Bus Frequency

3.3.4 Continuous Conversion

In the continuous conversion mode (ADCO = 1), the ADC continuously converts the selected channel filling the ADC data register (ADR) with new data after each conversion. Data from the previous conversion will be overwritten whether that data has been read or not. Conversions will continue until the ADCO bit is cleared. The COCO bit (ADSCR, \$003C) is set after each conversion and will stay set until the next read of the ADC data register.

When a conversion is in process and the ADSCR is written, the current conversion data should be discarded to prevent an incorrect reading.

3.3.5 Accuracy and Precision

The conversion process is monotonic and has no missing codes.

3.4 Interrupts

When the AIEN bit is set, the ADC module is capable of generating a central processor unit (CPU) interrupt after each ADC conversion. A CPU interrupt is generated if the COCO bit is at 0. The COCO bit is not used as a conversion complete flag when interrupts are enabled.

3.5 Low-Power Modes

The following subsections describe the ADC in low-power modes.

3.5.1 Wait Mode

The ADC continues normal operation during wait mode. Any enabled CPU interrupt request from the ADC can bring the microcontroller unit (MCU) out of wait mode. If the ADC is not required to bring the MCU out of wait mode, power down the ADC by setting the CH[4:0] bits in ADSCR to 1s before executing the WAIT instruction.



Chapter 4 Auto Wakeup Module (AWU)

4.1 Introduction

This section describes the auto wakeup module (AWU). The AWU generates a periodic interrupt during stop mode to wake the part up without requiring an external signal. Figure 4-1 is a block diagram of the AWU.

4.2 Features

Features of the auto wakeup module include:

- One internal interrupt with separate interrupt enable bit, sharing the same keyboard interrupt vector and keyboard interrupt mask bit
- Exit from low-power stop mode without external signals
- Selectable timeout periods
- Dedicated low-power internal oscillator separate from the main system clock sources

4.3 Functional Description

The function of the auto wakeup logic is to generate periodic wakeup requests to bring the microcontroller unit (MCU) out of stop mode. The wakeup requests are treated as regular keyboard interrupt requests, with the difference that instead of a pin, the interrupt signal is generated by an internal logic.

Writing the AWUIE bit in the keyboard interrupt enable register enables or disables the auto wakeup interrupt input (see Figure 4-1). A logic 1 applied to the AWUIREQ input with auto wakeup interrupt request enabled, latches an auto wakeup interrupt request.

Auto wakeup latch, AWUL, can be read directly from the bit 6 position of port A data register (PTA). This is a read-only bit which is occupying an empty bit position on PTA. No PTA associated registers, such as PTA6 data direction or PTA6 pullup exist for this bit.

Entering stop mode will enable the auto wakeup generation logic. An internal RC oscillator (exclusive for the auto wakeup feature) drives the wakeup request generator. Once the overflow count is reached in the generator counter, a wakeup request, AWUIREQ, is latched and sent to the KBI logic. See Figure 4-1.

Wakeup interrupt requests will only be serviced if the associated interrupt enable bit, AWUIE, in KBIER is set. The AWU shares the keyboard interrupt vector.

The overflow count can be selected from two options defined by the COPRS bit in CONFIG1. This bit was "borrowed" from the computer operating properly (COP) using the fact that the COP feature is idle (no MCU clock available) in stop mode. The typical values of the periodic wakeup request are (at room temperature):

- COPRS = 0: 650 ms @ 5 V, 875 ms @ 3 V
- COPRS = 1: 16 ms @ 5 V, 22 ms @ 3 V



Chapter 7 Central Processor Unit (CPU)

7.1 Introduction

The M68HC08 CPU (central processor unit) is an enhanced and fully object-code-compatible version of the M68HC05 CPU. The *CPU08 Reference Manual* (document order number CPU08RM/AD) contains a description of the CPU instruction set, addressing modes, and architecture.

7.2 Features

Features of the CPU include:

- Object code fully upward-compatible with M68HC05 Family
- 16-bit stack pointer with stack manipulation instructions
- 16-bit index register with x-register manipulation instructions
- 8-MHz CPU internal bus frequency
- 64-Kbyte program/data memory space
- 16 addressing modes
- Memory-to-memory data moves without using accumulator
- Fast 8-bit by 8-bit multiply and 16-bit by 8-bit divide instructions
- Enhanced binary-coded decimal (BCD) data handling
- Modular architecture with expandable internal bus definition for extension of addressing range beyond 64 Kbytes
- Low-power stop and wait modes

7.3 CPU Registers

Figure 7-1 shows the five CPU registers. CPU registers are not part of the memory map.



Central Processor Unit (CPU)



Figure 7-1. CPU Registers

7.3.1 Accumulator

The accumulator is a general-purpose 8-bit register. The CPU uses the accumulator to hold operands and the results of arithmetic/logic operations.



Figure 7-2. Accumulator (A)

7.3.2 Index Register

The 16-bit index register allows indexed addressing of a 64-Kbyte memory space. H is the upper byte of the index register, and X is the lower byte. H:X is the concatenated 16-bit index register.

In the indexed addressing modes, the CPU uses the contents of the index register to determine the conditional address of the operand.

The index register can serve also as a temporary data storage location.



Figure 7-3. Index Register (H:X)





Functional Description



Figure 8-2. IRQ Module Block Diagram

8.3.1 MODE = 1

If the MODE bit is set, the IRQ pin is both falling edge sensitive and low level sensitive. With MODE set, both of the following actions must occur to clear the IRQ interrupt request:

- Return of the IRQ pin to a high level. As long as the IRQ pin is low, the IRQ request remains active.
- IRQ vector fetch or software clear. An IRQ vector fetch generates an interrupt acknowledge signal to clear the IRQ latch. Software generates the interrupt acknowledge signal by writing a 1 to ACK in INTSCR. The ACK bit is useful in applications that poll the IRQ pin and require software to clear the IRQ latch. Writing to ACK prior to leaving an interrupt service routine can also prevent spurious interrupts due to noise. Setting ACK does not affect subsequent transitions on the IRQ pin. A falling edge that occurs after writing to ACK latches another interrupt request. If the IRQ mask bit, IMASK, is clear, the CPU loads the program counter with the IRQ vector address.

The IRQ vector fetch or software clear and the return of the IRQ pin to a high level may occur in any order. The interrupt request remains pending as long as the IRQ pin is low. A reset will clear the IRQ latch and the MODE control bit, thereby clearing the interrupt even if the pin stays low.

Use the BIH or BIL instruction to read the logic level on the IRQ pin.

8.3.2 MODE = 0

If the MODE bit is clear, the IRQ pin is falling edge sensitive only. With MODE clear, an IRQ vector fetch or software clear immediately clears the IRQ latch.

The IRQF bit in INTSCR can be read to check for pending interrupts. The IRQF bit is not affected by IMASK, which makes it useful in applications where polling is preferred.

NOTE

When using the level-sensitive interrupt trigger, avoid false IRQ interrupts by masking interrupt requests in the interrupt routine.



Chapter 9 Keyboard Interrupt Module (KBI)

9.1 Introduction

The keyboard interrupt module (KBI) provides six independently maskable external interrupts, which are accessible via the PTA0–PTA5 pins.

9.2 Features

Features of the keyboard interrupt module include:

- Six keyboard interrupt pins with separate keyboard interrupt enable bits and one keyboard interrupt mask
- Software configurable pullup device if input pin is configured as input port bit
- Programmable edge-only or edge and level interrupt sensitivity
- Exit from low-power modes

9.3 Functional Description

The keyboard interrupt module controls the enabling/disabling of interrupt functions on the six port A pins. These six pins can be enabled/disabled independently of each other. Refer to Figure 9-2.

9.3.1 Keyboard Operation

Writing to the KBIE0–KBIE5 bits in the keyboard interrupt enable register (KBIER) independently enables or disables each port A pin as a keyboard interrupt pin. Enabling a keyboard interrupt pin in port A also enables its internal pullup device irrespective of PTAPUEx bits in the port A input pullup enable register (see 12.2.3 Port A Input Pullup Enable Register). A logic 0 applied to an enabled keyboard interrupt pin latches a keyboard interrupt request.

A keyboard interrupt is latched when one or more keyboard interrupt inputs goes low after all were high. The MODEK bit in the keyboard status and control register controls the triggering mode of the keyboard interrupt.

- If the keyboard interrupt is edge-sensitive only, a falling edge on a keyboard interrupt input does not latch an interrupt request if another keyboard pin is already low. To prevent losing an interrupt request on one input because another input is still low, software can disable the latter input while it is low.
- If the keyboard interrupt is falling edge and low-level sensitive, an interrupt request is present as long as any keyboard interrupt input is low.



Functional Description



Figure 9-2. Keyboard Interrupt Block Diagram

If the MODEK bit is set, the keyboard interrupt inputs are both falling edge and low-level sensitive, and both of the following actions must occur to clear a keyboard interrupt request:

- Vector fetch or software clear A vector fetch generates an interrupt acknowledge signal to clear the interrupt request. Software may generate the interrupt acknowledge signal by writing a 1 to the ACKK bit in the keyboard status and control register (KBSCR). The ACKK bit is useful in applications that poll the keyboard interrupt inputs and require software to clear the keyboard interrupt request. Writing to the ACKK bit prior to leaving an interrupt service routine can also prevent spurious interrupts due to noise. Setting ACKK does not affect subsequent transitions on the keyboard interrupt inputs. A falling edge that occurs after writing to the ACKK bit latches another interrupt request. If the keyboard interrupt mask bit, IMASKK, is clear, the central processor unit (CPU) loads the program counter with the vector address at locations \$FFE0 and \$FFE1.
- Return of all enabled keyboard interrupt inputs to logic 1 As long as any enabled keyboard interrupt pin is at logic 0, the keyboard interrupt remains set. The auto wakeup interrupt input, AWUIREQ, will be cleared only by writing to ACKK bit in KBSCR or reset.

The vector fetch or software clear and the return of all enabled keyboard interrupt pins to logic 1 may occur in any order.

If the MODEK bit is clear, the keyboard interrupt pin is falling-edge sensitive only. With MODEK clear, a vector fetch or software clear immediately clears the keyboard interrupt request.

Reset clears the keyboard interrupt request and the MODEK bit, clearing the interrupt request even if a keyboard interrupt input stays at logic 0.

The keyboard flag bit (KEYF) in the keyboard status and control register can be used to see if a pending interrupt exists. The KEYF bit is not affected by the keyboard interrupt mask bit (IMASKK) which makes it useful in applications where polling is preferred.



Input/Output Ports (PORTS)

PTAPUE[5:0] — Port A Input Pullup Enable Bits

These read/write bits are software programmable to enable pullup devices on port A pins.

- 1 = Corresponding port A pin configured to have internal pull if its DDRA bit is set to 0
- 0 = Pullup device is disconnected on the corresponding port A pin regardless of the state of its DDRA bit

Table 12-1 summarizes the operation of the port A pins.

PTAPUE	DDRA	ΡΤΑ	I/O Pin	Accesses to DDRA	Access	es to PTA
Bit	Bit	Bit	Mode	Read/Write	Read	Write
1	0	X ⁽¹⁾	Input, V _{DD} ⁽²⁾	DDRA5-DDRA0	Pin	PTA5–PTA0 ⁽³⁾
0	0	Х	Input, Hi-Z ⁽⁴⁾	DDRA5-DDRA0	Pin	PTA5–PTA0 ⁽³⁾
Х	1	Х	Output	DDRA5-DDRA0	PTA5-PTA0	PTA5–PTA0 ⁽⁵⁾

Table 12-1. Port A Pin Functions

1. X = don't care

2. I/O pin pulled to V_{DD} by internal pullup.

3. Writing affects data register, but does not affect input.

4. Hi-Z = high impedance

5. Output does not apply to PTA2

12.3 Port B

Port B is an 8-bit general purpose I/O port. Port B is only available on the MC68HC908QY1, MC68HC908QY2, and MC68HC908QY4.

12.3.1 Port B Data Register

The port B data register (PTB) contains a data latch for each of the eight port B pins.



Figure 12-5. Port B Data Register (PTB)

PTB[7:0] — Port B Data Bits

These read/write bits are software programmable. Data direction of each port B pin is under the control of the corresponding bit in data direction register B. Reset has no effect on port B data.



System Integration Module (SIM)

13.6.3 Reset

All reset sources always have equal and highest priority and cannot be arbitrated.

13.6.4 Break Interrupts

The break module can stop normal program flow at a software programmable break point by asserting its break interrupt output. (See Chapter 15 Development Support.) The SIM puts the CPU into the break state by forcing it to the SWI vector location. Refer to the break interrupt subsection of each module to see how each module is affected by the break state.

13.6.5 Status Flag Protection in Break Mode

The SIM controls whether status flags contained in other modules can be cleared during break mode. The user can select whether flags are protected from being cleared by properly initializing the break clear flag enable bit (BCFE) in the break flag control register (BFCR).

Protecting flags in break mode ensures that set flags will not be cleared while in break mode. This protection allows registers to be freely read and written during break mode without losing status flag information.

Setting the BCFE bit enables the clearing mechanisms. Once cleared in break mode, a flag remains cleared even when break mode is exited. Status flags with a two-step clearing mechanism — for example, a read of one register followed by the read or write of another — are protected, even when the first step is accomplished prior to entering break mode. Upon leaving break mode, execution of the second step will clear the flag as normal.

13.7 Low-Power Modes

Executing the WAIT or STOP instruction puts the MCU in a low power- consumption mode for standby situations. The SIM holds the CPU in a non-clocked state. The operation of each of these modes is described below. Both STOP and WAIT clear the interrupt mask (I) in the condition code register, allowing interrupts to occur.

13.7.1 Wait Mode

In wait mode, the CPU clocks are inactive while the peripheral clocks continue to run. Figure 13-14 shows the timing for wait mode entry.

ADDRESS BUS	WAIT ADDR	WAIT AD	DR + 1	SAME	X	SAME	X
DATA BUS	PREVIOUS	S DATA			SAME	SAME	
R/W			у				

NOTE: Previous data can be operand data or the WAIT opcode, depending on the last instruction.

Figure 13-14. Wait Mode Entry Timing



A module that is active during wait mode can wake up the CPU with an interrupt if the interrupt is enabled. Stacking for the interrupt begins one cycle after the WAIT instruction during which the interrupt occurred. In wait mode, the CPU clocks are inactive. Refer to the wait mode subsection of each module to see if the module is active or inactive in wait mode. Some modules can be programmed to be active in wait mode.

Wait mode can also be exited by a reset (or break in emulation mode). A break interrupt during wait mode sets the SIM break stop/wait bit, SBSW, in the break status register (BSR). If the COP disable bit, COPD, in the configuration register is 0, then the computer operating properly module (COP) is enabled and remains active in wait mode.

Figure 13-15 and Figure 13-16 show the timing for wait recovery.





13.7.2 Stop Mode

In stop mode, the SIM counter is reset and the system clocks are disabled. An interrupt request from a module can cause an exit from stop mode. Stacking for interrupts begins after the selected stop recovery time has elapsed. Reset or break also causes an exit from stop mode.

The SIM disables the oscillator signals (BUSCLKX2 and BUSCLKX4) in stop mode, stopping the CPU and peripherals. Stop recovery time is selectable using the SSREC bit in the configuration register 1 (CONFIG1). If SSREC is set, stop recovery is reduced from the normal delay of 4096 BUSCLKX4 cycles down to 32. This is ideal for the internal oscillator, RC oscillator, and external oscillator options which do not require long start-up times from stop mode.

NOTE

External crystal applications should use the full stop recovery time by clearing the SSREC bit.



14.4 Functional Description

Figure 14-2 shows the structure of the TIM. The central component of the TIM is the 16-bit TIM counter that can operate as a free-running counter or a modulo up-counter. The TIM counter provides the timing reference for the input capture and output compare functions. The TIM counter modulo registers, TMODH:TMODL, control the modulo value of the TIM counter. Software can read the TIM counter value at any time without affecting the counting sequence.

The two TIM channels are programmable independently as input capture or output compare channels.



Figure 14-2. TIM Block Diagram

Development Support



RST, IRQ: Pins have internal (about 30K Ohms) pull up

PTA[0:5]: High current sink and source capability

PTA[0:5]: Pins have programmable keyboard interrupt and pull up

PTB[0:7]: Not available on 8-pin devices – MC68HC908QT1, MC68HC908QT2, and MC68HC908QT4 (see note in 12.1 Introduction)

ADC: Not available on the MC68HC908QY1 and MC68HC908QT1

Figure 15-1. Block Diagram Highlighting BRK and MON Blocks









Figure 15-12. Monitor Mode Circuit (Internal Clock, No High Voltage)

Simple monitor commands can access any memory address. In monitor mode, the MCU can execute code downloaded into RAM by a host computer while most MCU pins retain normal operating mode functions. All communication between the host computer and the MCU is through the PTA0 pin. A level-shifting and multiplexing interface is required between PTA0 and the host computer. PTA0 is used in a wired-OR configuration and requires a pullup resistor.

The monitor code has been updated from previous versions of the monitor code to allow enabling the internal oscillator to generate the internal clock. This addition, which is enabled when \overline{IRQ} is held low out of reset, is intended to support serial communication/programming at 9600 baud in monitor mode by using the internal oscillator, and the internal oscillator user trim value OSCTRIM (FLASH location \$FFC0, if programmed) to generate the desired internal frequency (3.2 MHz). Since this feature is enabled only when \overline{IRQ} is held low out of reset, it cannot be used when the reset vector is programmed (i.e., the value is not \$FFFF) because entry into monitor mode in this case requires V_{TST} on \overline{IRQ} . The \overline{IRQ} pin must remain low during this monitor session in order to maintain communication.

Table 15-1 shows the pin conditions for entering monitor mode. As specified in the table, monitor mode may be entered after a power-on reset (POR) and will allow communication at 9600 baud provided one of the following sets of conditions is met:

- If \$FFFE and \$FFFF do not contain \$FF (programmed state):
 - The external clock is 9.8304 MHz
 - IRQ = V_{TST}
- If \$FFFE and \$FFFF contain \$FF (erased state):
 - The external clock is 9.8304 MHz
 - $\overline{IRQ} = V_{DD}$ (this can be implemented through the internal \overline{IRQ} pullup)
 - If \$FFFE and \$FFFF contain \$FF (erased state):
 - IRQ = V_{SS} (internal oscillator is selected, no external clock required)



16.7 5-V Control Timing

Characteristic ⁽¹⁾	Symbol	Min	Max	Unit
Internal operating frequency	f _{OP} (f _{Bus})		8	MHz
Internal clock period (1/f _{OP})	t _{cyc}	125		ns
RST input pulse width low	t _{RL}	100		ns
IRQ interrupt pulse width low (edge-triggered)	t _{ILIH}	100	_	ns
IRQ interrupt pulse period	t _{ILIL}	Note ⁽²⁾	—	t _{cyc}

1. V_{DD} = 4.5 to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H; timing shown with respect to 20% V_{DD} and 70% V_{SS}, unless otherwise noted.

2. The minimum period is the number of cycles it takes to execute the interrupt service routine plus 1 t_{cyc} .



